PAA193 Dual Single-Pole, Normally Open OptoMOS® Relays

| Parameter | Rating | Units |
| :--- | :---: | :---: |
| Load Voltage | 600 | $\mathrm{~V}_{\mathrm{P}}$ |
| Load Current | 100 | $\mathrm{~mA}_{\mathrm{rms}} / \mathrm{mA}_{\mathrm{DC}}$ |
| On-Resistance (max) | 50 | $\Omega$ |

## Features

- $5000 \mathrm{~V}_{\text {rms }}$ Input/Output Isolation
- Low Drive Power Requirements
- High Reliability
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Small 8-Pin Package
- Flammability Rating UL 94 V-0
- Surface Mount Tape \& Reel Version Available


## Applications

- Instrumentation
- Multiplexers
- Data Acquisition
- Electronic Switching
- I/O Subsystems
- Meters (Watt-Hour, Water, Gas)
- Medical Equipment-Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls


## Description

The PAA193 is a dual normally open (1-Form-A) solid state relay that uses optically coupled relay technology to provide an enhanced $5000 \mathrm{~V}_{\text {rms }}$ input to output isolation barrier. The efficient MOSFET switches use IXYS Integrated Circuits' patented OptoMOS architecture. Highly efficient infrared LEDs provide the optically coupled control.

Dual OptoMOS relays provide a more compact design solution than discrete single-pole relays in a variety of applications. The dual relays save board space by incorporating two relays in a single 8-pin package.

## Approvals

- UL Recognized Component: File E76270
- CSA Certified Component: Certificate 1175739
- EN/IEC 60950-1 Certified Component:

Certificate available on our website

Ordering Information

| Part \# | Description |
| :--- | :--- |
| PAA193 | 8-Lead DIP (50/tube) |
| PAA193S | 8-Lead Surface Mount (50/tube) |
| PAA193STR | 8-Lead Surface Mount (1000/Reel) |

## Pin Configuration



## Switching Characteristics of Normally Open Devices

## Absolute Maximum Ratings @ $\mathbf{2 5}^{\circ} \mathrm{C}$

| Parameter | Ratings | Units |
| :--- | :---: | :---: |
| Blocking Voltage | 600 | $\mathrm{~V}_{\mathrm{p}}$ |
| Reverse Input Voltage | 5 | V |
| Input Control Current <br> Peak (10ms) | 50 | mA |
|  | 1 | A |
| Input Power Dissipation $^{1}$ | 150 | mW |
| Total Power Dissipation ${ }^{2}$ | 800 | mW |
| Isolation Voltage, Input to Output | 5000 | $\mathrm{~V}_{\text {rms }}$ |
| Operational Temperature | -40 to +85 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature | -40 to +125 | ${ }^{\circ} \mathrm{C}$ |
| 1 |  |  |
| ${ }^{1}$ Derate linearly $1.33 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ |  |  |
| Derate linearly $6.67 \mathrm{mw} /{ }^{\circ} \mathrm{C}$ |  |  |

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Typical values are characteristic of the device at $+25^{\circ} \mathrm{C}$, and are the result of engineering evaluations. They are provided for information purposes only, and are not part of the manufacturing testing requirements.

## Electrical Characteristics @ $25^{\circ} \mathrm{C}$

| Parameter | Conditions | Symbol | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output Characteristics |  |  |  |  |  |  |
| Load Current Continuous * Peak | - | $\mathrm{I}_{\mathrm{L}}$ | - | - | 100 | $\mathrm{mA}_{\text {rms }} / \mathrm{mA}_{\text {DC }}$ |
|  | $\mathrm{t}=10 \mathrm{~ms}$ | LLPK | - | - | $\pm 350$ | $m A_{p}$ |
| On-Resistance | $\mathrm{I}_{\mathrm{L}}=100 \mathrm{~mA}$ | $\mathrm{R}_{\mathrm{ON}}$ | - | - | 50 | $\Omega$ |
| Off-State Leakage Current | $\mathrm{V}_{\mathrm{L}}=600 \mathrm{~V}_{\mathrm{P}}$ | $\mathrm{I}_{\text {LEAK }}$ | - | - | 10 | $\mu \mathrm{A}$ |
| $\begin{aligned} & \hline \text { Switching Speeds } \\ & \text { Turn-On } \\ & \text { Turn-Off } \end{aligned}$ | $\mathrm{I}_{\mathrm{F}}=5 \mathrm{~mA}, \mathrm{~V}_{\mathrm{L}}=10 \mathrm{~V}$ | $\mathrm{t}_{\text {on }}$ | - | - | 5 | ms |
| Output Capacitance | $\mathrm{I}_{\mathrm{F}}=0 \mathrm{~mA}, \mathrm{~V}_{\mathrm{L}}=50 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ | $\mathrm{C}_{\text {OUT }}$ | - | 50 | - | pF |
| Input Characteristics |  |  |  |  |  |  |
| Input Control Current to Activate | $\mathrm{I}_{\mathrm{L}}=100 \mathrm{~mA}$ | $I_{\text {F }}$ | - | - | 5 | mA |
| Input Voltage Drop | $\mathrm{I}_{\mathrm{F}}=5 \mathrm{~mA}$ | $V_{F}$ | 0.9 | 1.2 | 1.5 | V |
| Reverse Input Current | $\mathrm{V}_{\mathrm{R}}=5 \mathrm{~V}$ | $I_{\text {R }}$ | - | - | 10 | $\mu \mathrm{A}$ |
| Common Characteristics |  |  |  |  |  |  |
| Capacitance, Input to Output | $\mathrm{V}_{10}=0 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ | $\mathrm{C}_{10}$ | - | 3 | - | pF |

*NOTE: If both poles operate simultaneously, then load current must be derated in order not to exceed the package power dissipation value.

## PERFORMANCE DATA*




*Unless otherwise noted, data presented in these graphs is typical of device operation at $25^{\circ} \mathrm{C}$.

## PERFORMANCE DATA*



Typical Leakage vs. Temperature Measured across Pins 5\&6 or 7\&8


*Unless otherwise noted, data presented in these graphs is typical of device operation at $25^{\circ} \mathrm{C}$.
For guaranteed parameters not indicated in the written specifications, please contact our application department.

## Manufacturing Information

Moisture Sensitivity

All plastic encapsulated semiconductor packages are susceptible to moisture ingression. IXYS Integrated Circuits classifies its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, IPC/JEDEC J-STD-020, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a Moisture Sensitivity Level (MSL) classification as shown below, and should be handled according to the requirements of the latest version of the joint industry standard IPC/JEDEC J-STD-033.

| Device | Moisture Sensitivity Level (MSL) Classification |
| :---: | :---: |
| PAA193 / PAA193S | MSL 1 |

## ESD Sensitivity



This product is ESD Sensitive, and should be handled according to the industry standard JESD-625.

## Soldering Profile

Provided in the table below is the Classification Temperature $\left(T_{C}\right)$ of this product and the maximum dwell time the body temperature of this device may be $\left(T_{C}-5\right)^{\circ} \mathrm{C}$ or greater. The classification temperature sets the Maximum Body Temperature allowed for this device during lead-free reflow processes. For through-hole devices, and any other processes, the guidelines of J-STD-020 must be observed.

| Device | Classification Temperature $\left(T_{c}\right)$ | Dwell Time $\left(t_{p}\right)$ | Max Reflow Cycles |
| :---: | :---: | :---: | :---: |
| PAA193 | $250^{\circ} \mathrm{C}$ | 30 seconds | 1 |
| PAA193S | $250^{\circ} \mathrm{C}$ | 30 seconds | 3 |

## Board Wash

IXYS Integrated Circuits recommends the use of no-clean flux formulations. Board washing to reduce or remove flux residue following the solder reflow process is acceptable provided proper precautions are taken to prevent damage to the device. These precautions include, but are not limited to: using a low pressure wash and providing a follow up bake cycle sufficient to remove any moisture trapped within the device due to the washing process. Due to the variability of the wash parameters used to clean the board, determination of the bake temperature and duration necessary to remove the moisture trapped within the package is the responsibility of the user (assembler). Cleaning or drying methods that employ ultrasonic energy may damage the device and should not be used. Additionally, the device must not be exposed to flux or solvents that are Chlorine- or Fluorine-based.

ROHS


## Mechanical Dimensions

## PAA193



$\frac{\text { Dimensions }}{\mathrm{mm}}$

## PAA193S



PCB Land Pattern



## PAA193STR Tape \& Reel



$$
\begin{gathered}
\mathrm{mm} \\
\text { (inches) }
\end{gathered}
$$

1. Dimensions carry tolerances of EIA Standard 481-2
2. Tape complies with all "Notes" for constant dimensions listed on page 5 of EIA-481-2

For additional information please visit our website at: www.ixysic.com
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